

YK3080K



康比電子
HORNBY ELECTRONIC

N-Channel Enhancement Mode Field Effect Transistor

General Description

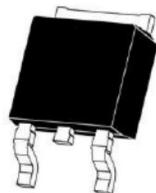
The YK3080K uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

Application

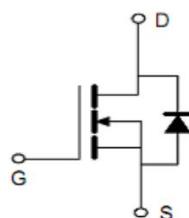
- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply

Features

- $V_{DS} = 30V, I_D = 80A$
- $R_{DS(ON)} < 6m\Omega @ V_{GS}=10V$
- $R_{DS(ON)} < 9m\Omega @ V_{GS}=4.5V$
- High density cell design for ultra low R_{dson}
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high EAS
- Excellent package for good heat dissipation



TO-252-2L top view



Package Marking and Ordering Information

| Device Marking | Device | Device Package | Reel Size | Reel | Carton |
|----------------|---------|----------------|-----------|---------|----------|
| 3080K | YK3080K | TO-252-2L | 13inch | 2500pcs | 50000PCS |

Absolute Maximum Ratings ($T_A=25^\circ C$ unless otherwise noted)

| Parameter | Symbol | Maximum | Units |
|--|-----------|------------|-------|
| Drain-Source Voltage | V_{DSS} | 30 | V |
| Gate-Source Voltage | V_{GSS} | ± 20 | V |
| Drain Current-Continuous @ $T_C=25^\circ C$ | I_D | 80 | A |
| Pulsed Drain Current | I_{DM} | 170 | A |
| Maximum Power Dissipation @ $T_C=25^\circ C$ | P_D | 58 | W |
| Single pulse avalanche energy (Note 5) | EAS | 196 | mJ |
| Operating Junction and Storage Temperature Range | T_J | -55 ~ +150 | °C |

Thermal Characteristics

| | | | |
|--|-----------|-----|------|
| Thermal Resistance Junction-to-Case (Note 2) | $R_{θJC}$ | 2.2 | °C/W |
|--|-----------|-----|------|

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Electrical Characteristics ($T_A=25^\circ C$ unless otherwise noted)

| Parameter | Symbol | Condition | Min | Typ | Max | Unit |
|--|--------------|---|-----|------|-----------|-----------|
| Off Characteristics | | | | | | |
| Drain-Source Breakdown Voltage | BV_{DSS} | $V_{GS}=0V, I_D=250\mu A$ | 30 | | - | V |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{DS}=30V, V_{GS}=0V$ | - | - | 1 | μA |
| Gate-Body Leakage Current | I_{GSS} | $V_{GS}=\pm 20V, V_{DS}=0V$ | - | - | ± 100 | nA |
| On Characteristics ^(Note 3) | | | | | | |
| Gate Threshold Voltage | $V_{GS(th)}$ | $V_{DS}=V_{GS}, I_D=250\mu A$ | 1 | 1.6 | 3 | V |
| Drain-Source On-State Resistance | $R_{DS(ON)}$ | $V_{GS}=10V, I_D=30A$ | - | 4.5 | 6 | $m\Omega$ |
| | | $V_{GS}=4.5V, I_D=24A$ | - | 6.8 | 9 | |
| Forward Transconductance | g_{FS} | $V_{DS}=5V, I_D=24A$ | 20 | - | - | S |
| Dynamic Characteristics ^(Note 4) | | | | | | |
| Input Capacitance | C_{iss} | $V_{DS}=15V,$ $V_{GS}=0V,$ $F=1MHz$ | - | 1720 | - | pF |
| Output Capacitance | C_{oss} | | - | 235 | - | |
| Reverse Transfer Capacitance | C_{rss} | | - | 218 | - | |
| Switching Characteristics ^(Note 4) | | | | | | |
| Turn-on Delay Time | $T_{d(on)}$ | $V_{DD}=15V,$ $I_D=30A,$ $V_{GS}=10V,$ $R_G=3\Omega$ | - | 7.5 | - | ns |
| Turn-on Rise Time | T_r | | - | 14.5 | - | |
| Turn-Off Delay Time | $T_{d(OFF)}$ | | - | 33 | - | |
| Turn-Off Fall Time | T_f | | - | 10.3 | - | |
| Total Gate Charge | Q_g | $V_{DS}=15V,$ $I_D=30A,$ $V_{GS}=10V$ | - | 33.7 | - | nC |
| Gate-Source Charge | Q_{gs} | | - | 8.5 | - | |
| Gate-Drain Charge | Q_{gd} | | - | 7.5 | - | |
| Drain-Source Diode Characteristics | | | | | | |
| Diode Forward Voltage ^(Note 3) | V_{SD} | $I_S=30A, V_{GS}=0V$ | - | - | 1.2 | V |
| Diode Forward Current ^(Note 2) | I_S | | - | - | 80 | A |

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, $t \leq 10$ sec.
3. Pulse Test: Pulse Width $\leq 300\mu s$, Duty Cycle $\leq 2\%$.
4. Guaranteed by design, not subject to production
5. EAS condition: $T_j=25^\circ C, V_{DD}=15V, V_G=10V, L=0.5mH, R_g=25\Omega, I_{AS}=35A$

Typical Electrical and Thermal Characteristics

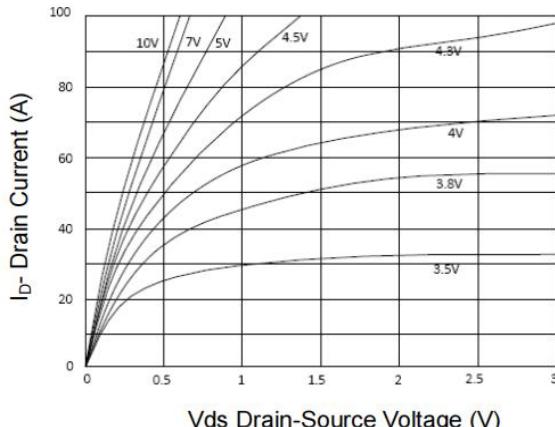


Figure 1 Output Characteristics

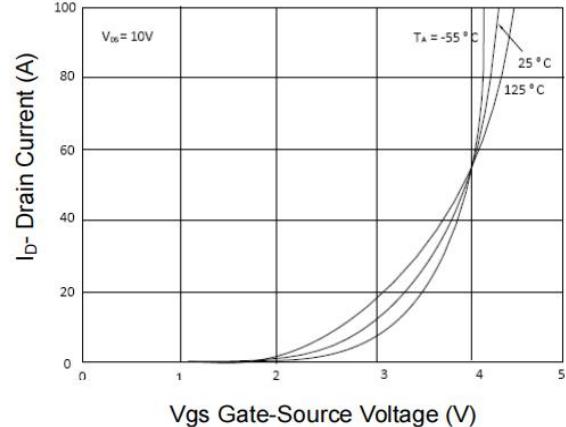


Figure 2 Transfer Characteristics

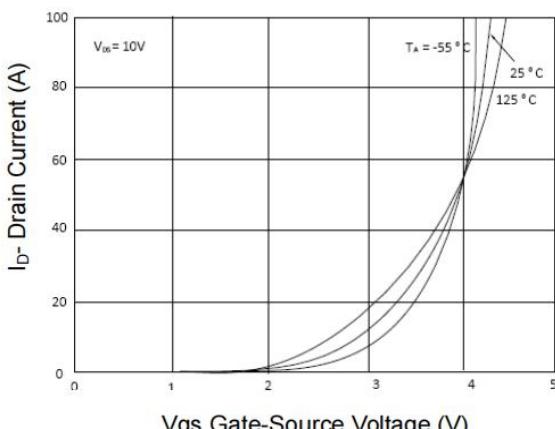


Figure 2 Transfer Characteristics

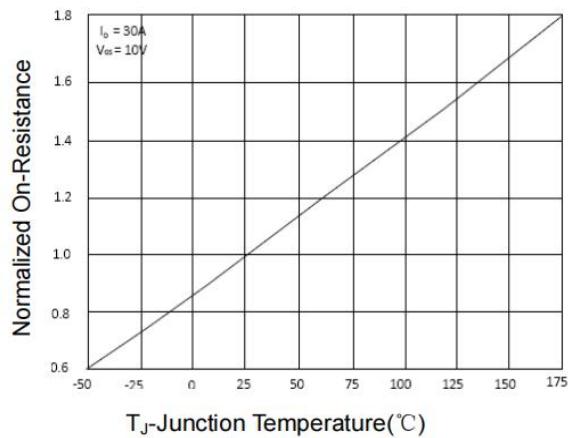


Figure 4 Rdson-Junction Temperature

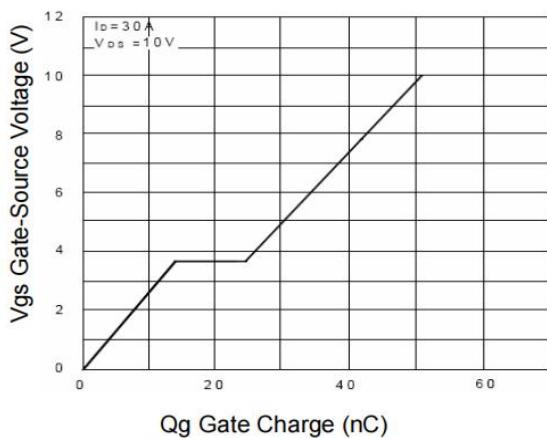


Figure 5 Gate Charge

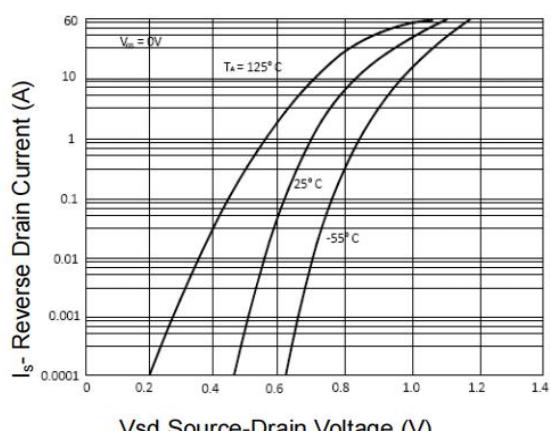


Figure 6 Source- Drain Diode Forward

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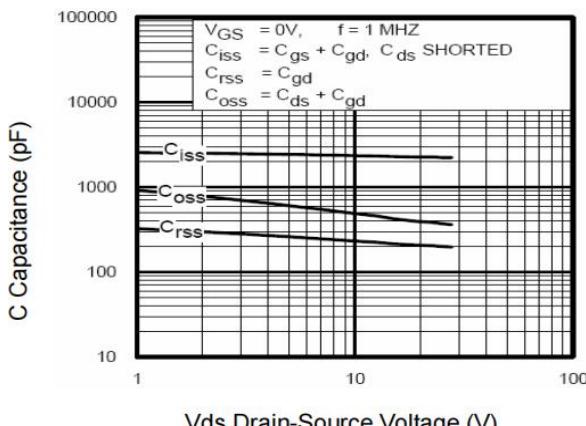


Figure 7 Capacitance vs Vds

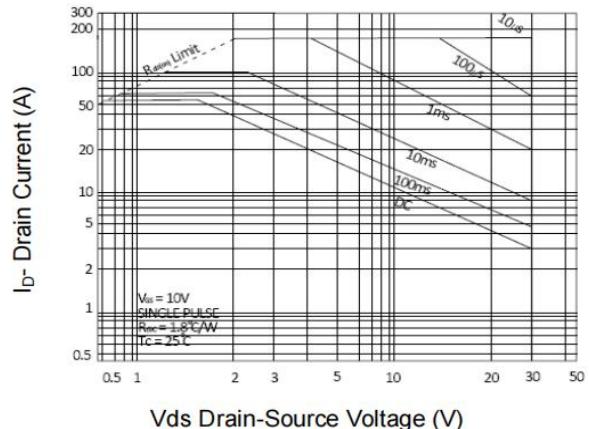


Figure 8 Safe Operation Area

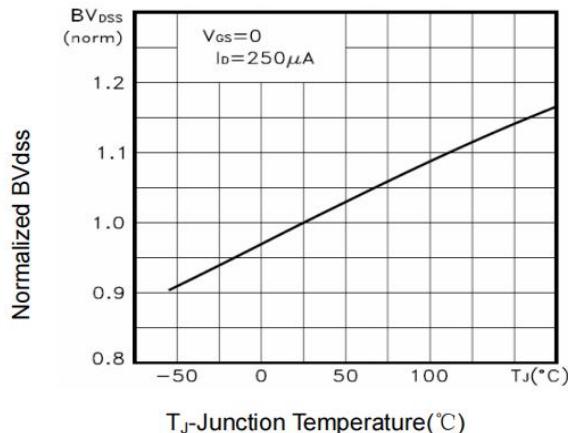


Figure 9 BV_{DSS} vs Junction Temperature

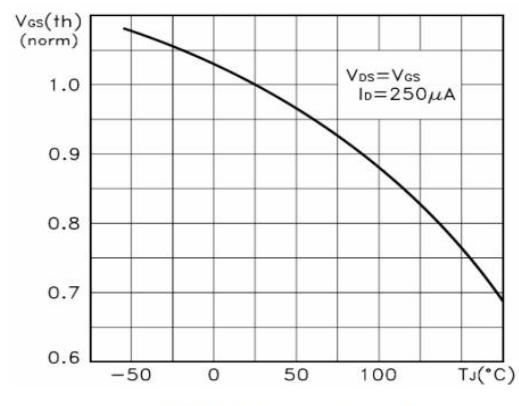


Figure 10 $V_{GS(th)}$ vs Junction Temperature

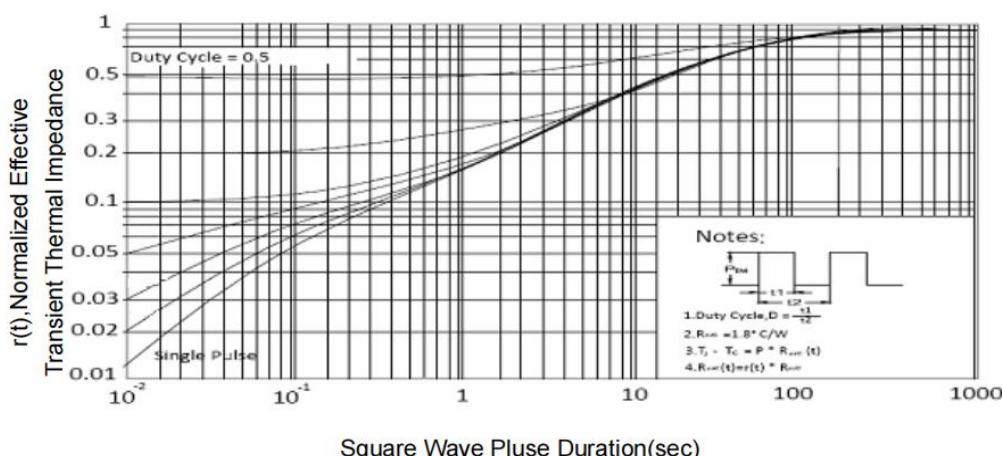
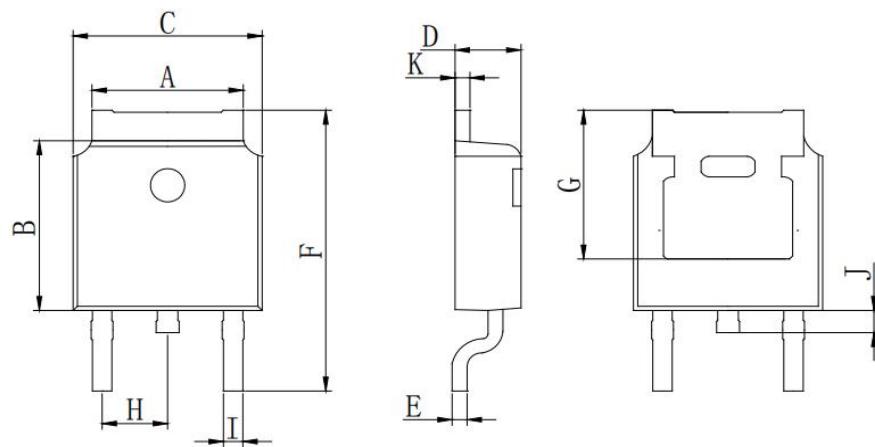


Figure 11 Normalized Maximum Transient Thermal Impedance

TO-252 Package Information**TO-252**

| Dimension | Min | max |
|-----------|------|-------|
| A | 5.05 | 5.65 |
| B | 5.80 | 6.40 |
| C | 6.25 | 6.85 |
| D | 2.20 | 2.40 |
| E | 0.40 | 0.60 |
| F | 9.71 | 10.31 |
| G | 5.05 | 5.65 |
| H | 2.10 | 2.50 |
| I | 0.7 | 0.9 |
| J | 0.5 | 0.8 |
| K | 0.4 | 0.6 |